TE Internal #: 2033993-2

PCB Mount Header, Right Angle, Partially Shrouded, Right Guide

Location, Signal, Board Mount, -65 – 125 °C [-85 – 257 °F]

View on TE.com >



Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors > Ruggedized Connector, 10 Gb/s



Mating Alignment: With

Mating Alignment Type: Polarization

PCB Connector Type: PCB Mount Header

PCB Mount Orientation: Right Angle

Shroud Style: Partially Shrouded

All Ruggedized Connector, 10 Gb/s (2)

Features

Product Type Features

Connector & Contact Terminates To	Printed Circuit Board
Connector System	Board-to-Board
PCB Connector Type	PCB Mount Header
Shroud Style	Partially Shrouded

Configuration Features

Backplane Architecture	Traditional Backplane
PCB Mount Orientation	Right Angle
Guide Location	Right

Contact Features

Contact Current Rating (Max)	1.5 A	

Mechanical Attachment

Mating Alignment	With
Mating Alignment Type	Polarization
Connector Mounting Type	Board Mount

Housing Features

Number of Shrouded Sides	0
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Usage Conditions



Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
Operation/Application	
Circuit Application	Signal

Product Compliance

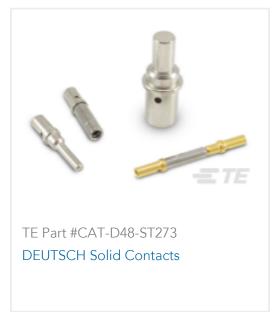
For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2019 (197) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Not Yet Reviewed for halogen content
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

Customers Also Bought















Documents

Product Drawings

HSR, 2 bay, D. card conn.1UPM and 1 HMzd

English

CAD Files

Customer View Model

ENG_CVM_CVM_2033993-2_C.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2033993-2_C.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2033993-2_C.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

Mezalok Connector Brochure

English